

Ixef® 2011

polyarylamide

lxef® 2011 is a general purpose, 42% mineral reinforced polyarylamide which exhibits high strength and stiffness, low warpage, and outstanding surface gloss.

- Natural: lxef® 2011/0000
- Black: Ixef® 2011/9000
- Custom Colorable

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Material Status	 Commercial: Active 	
Availability	 Africa & Middle East Asia Pacific Europe	Latin AmericaNorth America
Filler / Reinforcement	 Mineral, 42% Filler by Weight 	
Features	Chemical ResistantCreep ResistantGood Dimensional StabilityHigh FlowHigh Stiffness	 High Strength Low Moisture Absorption Low Warpage Outstanding Surface Finish
Uses	 Appliance Components Appliances Automotive Applications Automotive Electronics Automotive Interior Parts Automotive Under the Hood Bushings Business Equipment 	 Camera Applications Furniture Gears Industrial Applications Lawn & Garden Equipment Machine/Mechanical Parts Metal Replacement Power/Other Tools
RoHS Compliance	 RoHS Compliant 	
Appearance	• Black	 Colors Available
Forms	 Pellets 	
Processing Method	Injection Molding	

Physical	Typical Value Unit	Test method
Density	1.58 g/cm³	ISO 1183
Molding Shrinkage - Flow	0.15 to 0.35 %	Internal Method
Water Absorption (24 hr, 23°C)	0.30 %	ISO 62
Moisture Absorption - Equil, 65% RH	2.0 %	Internal Method

Mechanical	Typical Value	Unit	Test method
Tensile Modulus	15300	МРа	ISO 527-1
Tensile Stress (Break)	130	МРа	ISO 527-2
Tensile Strain (Break)	1.3	%	ISO 527-2
Flexural Modulus	14200	МРа	ISO 178
Flexural Stress	180	МРа	ISO 178

Impact	Typical Value	Unit	Test method
Charpy Notched Impact Strength	2.1	kJ/m²	ISO 179
Charpy Unnotched Impact Strength	29	kJ/m²	ISO 179
Notched Izod Impact Strength	2.2	kJ/m²	ISO 180
Unnotched Izod Impact Strength	24	kJ/m²	ISO 180
Thermal	Typical Value	Unit	Test method
Deflection Temperature Under Load	. , , , , , , , , , , , , , , , , , , ,		ISO 75-2/A
1.8 MPa, Unannealed	165	°C	,
Melting Temperature	235	°C	ISO 11357-3
CLTE - Flow	1.8E-5	cm/cm/°C	ISO 11359-2
Electrical	Typical Value	Unit	Test method
Surface Resistivity	1.0E+10		IEC 60093
Volume Resistivity		ohms·cm	IEC 60093
Electric Strength	24	kV/mm	IEC 60243-1
Dielectric Constant (110 Hz)	4.30	·	IEC 60250
Dissipation Factor (110 Hz)	9.0E-3		IEC 60250
Comparative Tracking Index	520	V	IEC 60112
Flammability	Typical Value	Unit	Test method
Flame Rating ¹	HB	Offic	UL 94
Oxygen Index	29	%	ISO 4589-2
Injection	Typical Value	Unit	
Injection Drying Temperature	Typical Value		
Drying Time	0.50 to 1.5		
Rear Temperature	250 to 260		
Front Temperature	260 to 290		
Processing (Melt) Temp	280		
Mold Temperature	120 to 140		
Screw L/D Ratio	15.0:1.0 to 20.0:1.0		

Injection Notes

Hot Runners: 250°C to 260°C (482°F to 500°F)

Injection Pressure: rapid

Storage

lxef® compounds are shipped in moisture-resistant packages at moisture levels according to specifications. Sealed, undamaged bags should be preferably stored in a dry room at a maximum temperature of 50°C (122°F) and should be protected from possible damage. If only a portion of a package is used, the remaining material should be transferred into a sealable container. It is recommended that lxef® resins be dried prior to molding following the recommendations found in this datasheet and/or in the lxef® processing guide.

Drying

The material as supplied is ready for molding without drying. However, If the bags have been open for longer than 24 hours, the material needs to be dried. When using a desiccant air dryer with dew point of -28°C (-18°F) or lower, these guidelines can be followed: 0.5-1.5 hour at 120°C (248°F), 1-3 hours at 100°C (212°F), or 1-7 hours at 80°C (176°F).

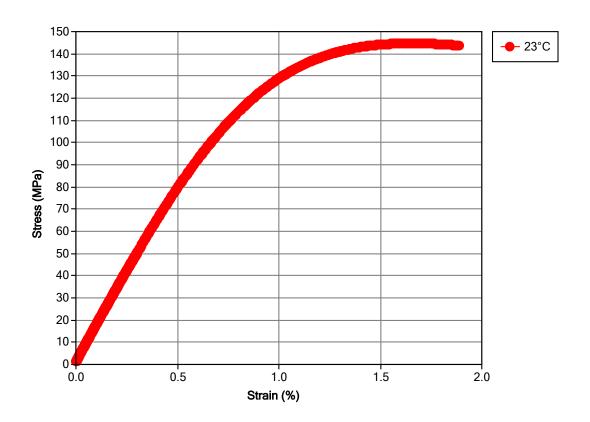
Injection Molding

IXEF 2011 compound can be readily injection molded in most screw injection molding machines. A general purpose screw is recommended, with minimum back pressure.

The measured melt temperature should be about 280°C (536°F), and the barrel temperatures should be around 250 to 260°C (482 to 500°F) in the rear zone, gradually increasing to 260°C to 290°C (500°F to 554°F) in the front zone. If hot runners are used, they should be set to 250°C to 260°C (482°F to 500°F).

To maximize crystallinity, the temperature of the mold cavity surface must be held between 120°C and 140°C (248°F and 284°F). Molding at lower temperatures will produce articles that may warp, have poor surface appearance, and have a greater tendency to creep. Set injection pressure to give rapid injection. Adjust holding pressure and hold time to maximize part weight. Transfer from injection to hold pressure at the screw position just before the part is completely filled (95%–99%).

Isothermal Stress vs. Strain (ISO 11403)



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Notes

Typical properties: these are not to be construed as specifications.

¹ These flammability ratings are not intended to reflect hazards presented by these or any other materials under actual fire conditions.

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